

SECTION 27 05 26
GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

PART 1 - GENERAL

1.1 DESCRIPTION

- A. This section specifies general grounding and bonding requirements of telecommunication installations for equipment operations.
- B. The terms "connect" and "bond" are used interchangeably in this specification and have the same meaning.

1.2 RELATED WORK

- A. Section 27 05 11, REQUIREMENTS FOR COMMUNICATIONS INSTALLATIONS:
 General electrical requirements and items that are common to more than one section of Division 27.

1.3 SUBMITTALS

- A. Submit in accordance with Section 27 05 11, REQUIREMENTS FOR COMMUNICATIONS INSTALLATIONS.
- B. Shop Drawings:
 - 1. Sufficient information, clearly presented, shall be included to determine compliance with drawings and specifications.
 - 2. Include the location of system grounding electrode connections and the routing of aboveground grounding electrode conductors.
- C. Test Reports: Provide certified test reports of ground resistance.
- D. Certifications: Two weeks prior to final inspection, submit four copies of the following to the Resident Engineer:
 - 1. Certification that the materials and installation is in accordance with the drawings and specifications.
 - 2. Certification, by the Contractor, that the complete installation has been properly installed and tested.

1.4 APPLICABLE PUBLICATIONS

Publications listed below (including amendments, addenda, revisions, supplements, and errata) form a part of this specification to the extent referenced. Publications are referenced in the text by the basic designation only.

- A. American Society for Testing and Materials (ASTM):
 B1-2001.....Standard Specification for Hard-Drawn Copper
 Wire

- B8-2004.....Standard Specification for Concentric-Lay-Stranded Copper Conductors, Hard, Medium-Hard, or Soft
- B. Institute of Electrical and Electronics Engineers, Inc. (IEEE):
81-1983.....IEEE Guide for Measuring Earth Resistivity, Ground Impedance, and Earth Surface Potentials of a Ground System
- C. National Fire Protection Association (NFPA):
70-2005.....National Electrical Code (NEC)
- D. Telecommunications Industry Association, (TIA)
J-STO-607-A-2002.....Commercial Building Grounding (Earthing) and Bonding Requirements for Telecommunications
- E. Underwriters Laboratories, Inc. (UL):
44-2005Thermoset-Insulated Wires and Cables
83-2003Thermoplastic-Insulated Wires and Cables
467-2004Grounding and Bonding Equipment
486A-486B-2003Wire Connectors

PART 2 - PRODUCTS

2.1 GROUNDING AND BONDING CONDUCTORS

- A. Equipment grounding conductors shall be UL 83 insulated stranded copper, except that sizes 6 mm² (10 AWG) and smaller shall be solid copper. Insulation color shall be continuous green for all equipment grounding conductors, except that wire sizes 25 mm² (4 AWG) and larger shall be permitted to be identified per NEC.
- B. Bonding conductors shall be ASTM B8 bare stranded copper, except that sizes 6 mm² (10 AWG) and smaller shall be ASTM B1 solid bare copper wire.

2.2 GROUND CONNECTIONS

- A. Above Grade:
1. Bonding Jumpers: compression type connectors, using zinc-plated fasteners and external tooth lockwashers.
 2. Ground Busbars: Two-hole compression type lugs using tin-plated copper or copper alloy bolts and nuts.
 3. Rack and Cabinet Ground Bars: one-hole compression-type lugs using zinc-plated or copper alloy fasteners.
- B. Cable Shields: Make ground connections to multipair communications cables with metallic shields using shield bonding connectors with screw stud connection.

PART 3 - EXECUTION**3.1 GENERAL**

- A. Ground in accordance with the NEC, as shown on drawings, and as hereinafter specified.

3.2 INACCESSIBLE GROUNDING CONNECTIONS

Make grounding connections, which are buried or otherwise normally inaccessible (except connections for which periodic testing access is required) by exothermic weld.

3.3 CORROSION INHIBITORS

When making ground and ground bonding connections, apply a corrosion inhibitor to all contact surfaces. Use corrosion inhibitor appropriate for protecting a connection between the metals used.

3.4 CONDUCTIVE PIPING

- A. Bond all conductive piping systems, interior and exterior, to the building to the grounding electrode system. Bonding connections shall be made as close as practical to the equipment ground bus.

3.5 COMMUNICATIONS RACEWAY GROUNDING

- A. Conduit: Use insulated 16 mm² (6 AWG) bonding jumpers to ground metallic conduit at each end and to bond at all intermediate metallic enclosures.

3.6 GROUND RESISTANCE

- A. Grounding system resistance to ground shall not exceed 5 ohms. Make necessary modifications or additions to the grounding electrode system for compliance without additional cost to the Government. Final tests shall assure that this requirement is met.
- B. Resistance of the grounding electrode system shall be measured using a four-terminal fall-of-potential method as defined in IEEE 81. Ground resistance measurements shall be made before the electrical distribution system is energized and shall be made in normally dry conditions not less than 48 hours after the last rainfall. Resistance measurements of separate grounding electrode systems shall be made before the systems are bonded together below grade. The combined resistance of separate systems may be used to meet the required resistance, but the specified number of electrodes must still be provided.

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